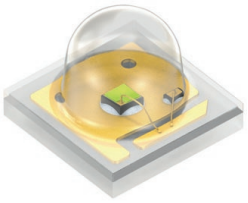
LUW CN7M



OSLON® SX ECE

The OSLON® SX combine a compact size (small footprint: 3x3mm) with a high efficiency and a electrically insulated thermal pad.

Applications

- Cluster, Button Backlighting
- Custom Tuning
- Electronic Equipment
- Head-Up Display LED & Laser
- Industrial Automation (Machine Controls, Light Barriers, Vision Controls)
- Interior Illumination (e.g. Ambient Map)
- Transportation, Plane, Ship

Features:

- Package: SMD ceramic package with silicone lens
- Chip technology: ThinGaN
- Typ. Radiation: 90°
- Color: Cx = 0.32, Cy = 0.32 acc. to CIE 1931 (• ultra white)
- Optical efficacy: 61 lm/W
- Corrosion Robustness Class: 3B
- Qualifications: The product qualification test plan is based on the guidelines of AEC-Q101-REV-C, Stress Test Qualification for Automotive Grade Discrete Semiconductors.
- ESD: 8 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)

Ordering Information

Type	Luminous Flux [1] I_F = 200 mA Φ_V	Ordering Code
LUW CN7M-HYJY-EMKM-1	33 ... 61 lm	Q65110A9509

Discontinued

Maximum Ratings

Parameter	Symbol		Values
Operating Temperature	T_{op}	min. max.	-40 °C 125 °C
Storage Temperature	T_{stg}	min. max.	-40 °C 125 °C
Junction Temperature	T_j	max.	150 °C
Forward Current T_S = 25 °C	I_F	min. max.	30 mA 250 mA
Surge Current t ≤ 10 µs; D = 0.005 ; T_S = 25 °C	I_{FS}	max.	1000 mA
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)	V_{ESD}		8 kV
Reverse current [2)]	I_R	max.	200 mA

Characteristics

I_F = 200 mA; T_S = 25 °C

Parameter	Symbol		Values
Chromaticity Coordinate [3]	Cx	typ.	0.32
	Cy	typ.	0.32
Viewing angle at 50% I_V	2φ	typ.	90 °
Forward Voltage [4] I_F = 200 mA	V_F	min. typ. max.	2.90 V 3.40 V 4.10 V
Reverse voltage (ESD device)	$V_{R\ ESD}$	min.	45 V
Reverse voltage [2] I_R = 20 mA	V_R	max.	1.2 V
Real thermal resistance junction/solderpoint [5]	$R_{thJS\ real}$	typ. max.	27 K / W 30 K / W

Brightness Groups

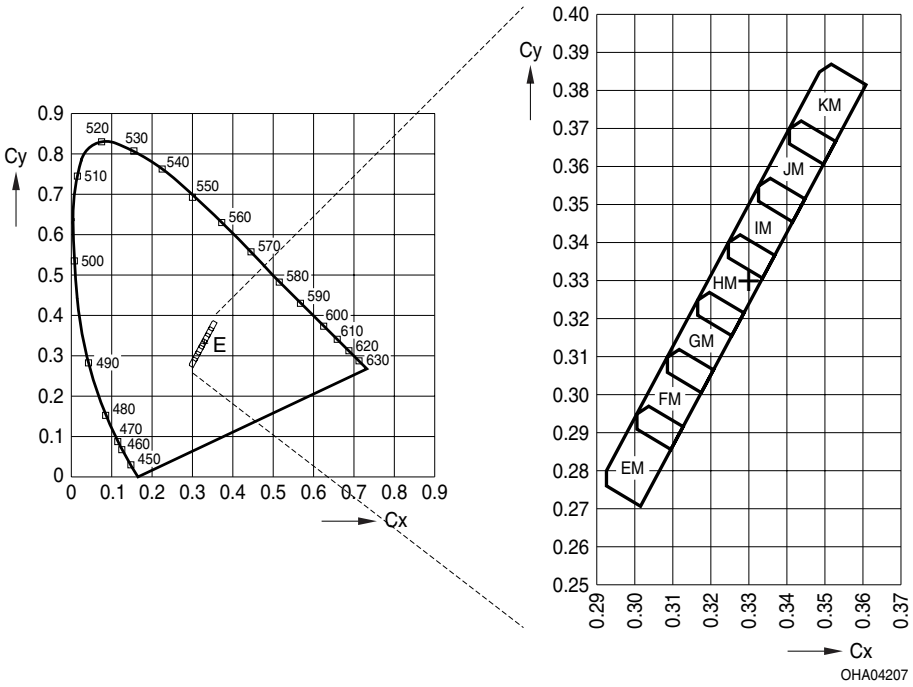
Group	Luminous Flux [1] I_F = 200 mA min. Φ_V	Luminous Flux [1] I_F = 200 mA max. Φ_V	Luminous Intensity [6] I_F = 200 mA typ. I_v
HY	33 lm	39 lm	25 cd
HZ	39 lm	45 lm	29 cd
JX	45 lm	52 lm	34 cd
JY	52 lm	61 lm	40 cd

Forward Voltage Groups

Group	Forward Voltage [4] I_F = 200 mA min. V_F	Forward Voltage [4] I_F = 200 mA max. V_F
4	2.90 V	3.20 V
5	3.20 V	3.50 V
6	3.50 V	3.80 V
7	3.80 V	4.10 V

Discontinued

Chromaticity Coordinate Groups [3)]



Chromaticity Coordinate Groups [3)]

Group	Cx	Cy	Group	Cx	Cy	Group	Cx	Cy
EM	0.3018	0.2704	HM	0.3258	0.3154	JM	0.3418	0.3454
	0.2926	0.2757		0.3166	0.3207		0.3326	0.3507
	0.2926	0.2797		0.3166	0.3247		0.3326	0.3547
	0.3006	0.2947		0.3246	0.3397		0.3406	0.3697
	0.3038	0.2967		0.3278	0.3417		0.3438	0.3717
	0.3130	0.2914		0.3370	0.3364		0.3530	0.3664
FM	0.3098	0.2854	IM	0.3338	0.3304	KM	0.3498	0.3604
	0.3006	0.2907		0.3246	0.3357		0.3406	0.3657
	0.3006	0.2947		0.3246	0.3397		0.3406	0.3697
	0.3086	0.3097		0.3326	0.3547		0.3486	0.3847
	0.3118	0.3117		0.3358	0.3567		0.3518	0.3867
	0.3210	0.3064		0.3450	0.3514		0.3610	0.3814
GM	0.3178	0.3004						
	0.3086	0.3057						
	0.3086	0.3097						
	0.3166	0.3247						
	0.3198	0.3267						
	0.3290	0.3214						

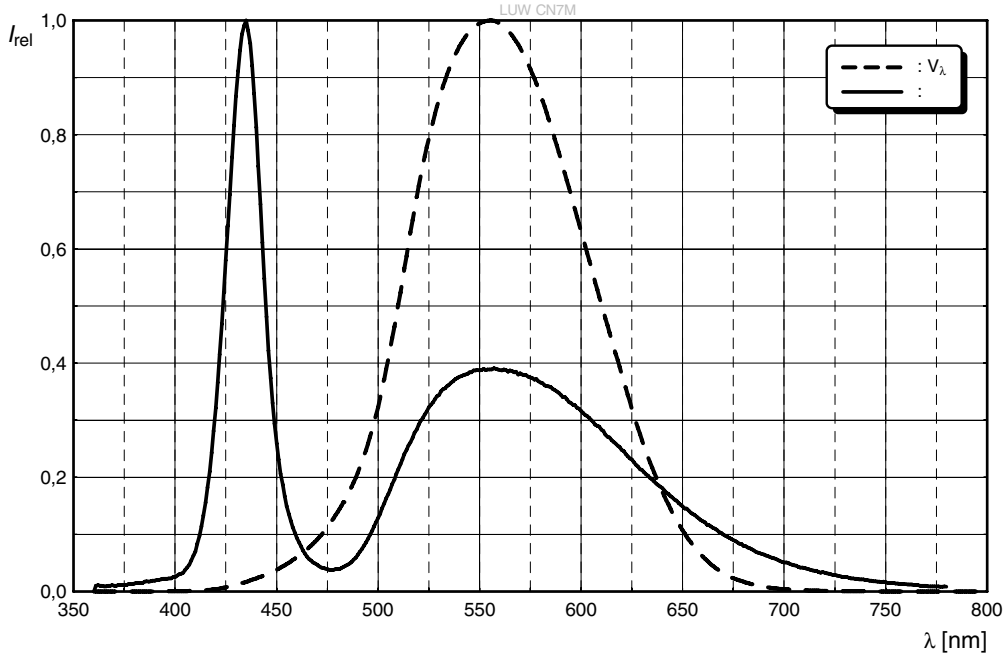
Group Name on Label

Example: HY-EM-4

Brightness	Color Chromaticity	Forward Voltage
HY	EM	4

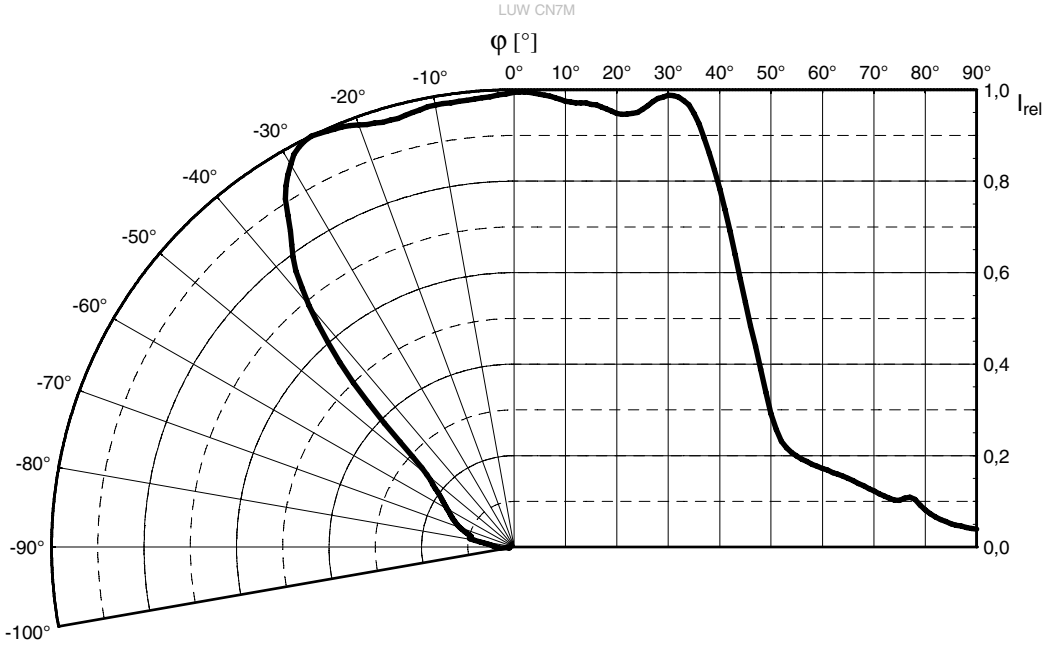
Relative Spectral Emission [6]

$\Phi_{rel} = f(\lambda)$; I_F = 200 mA; T_S = 25 °C



Radiation Characteristics [6]

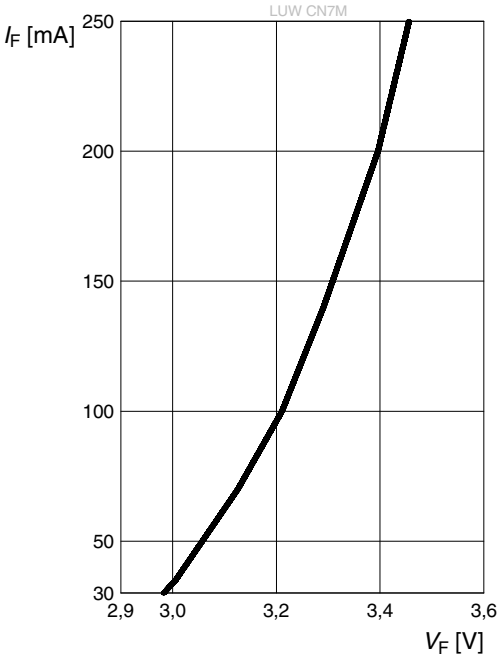
$I_{rel} = f(\phi)$; T_S = 25 °C



Discontinued

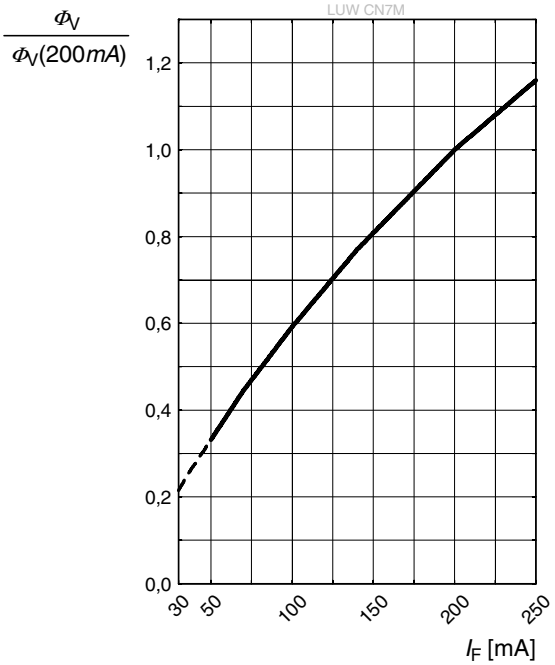
Forward current 6), 7)

$I_F = f(V_F)$; T_S = 25 °C



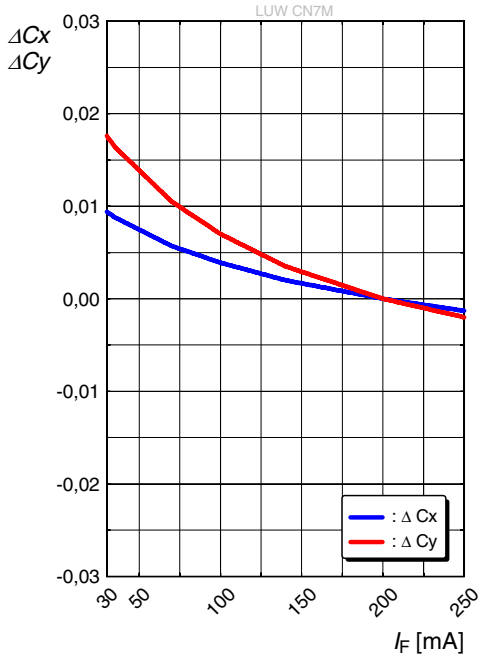
Relative Luminous Flux 6), 7)

$\Phi_v/\Phi_v(200\ mA) = f(I_F)$; T_S = 25 °C



Chromaticity Coordinate Shift 6)

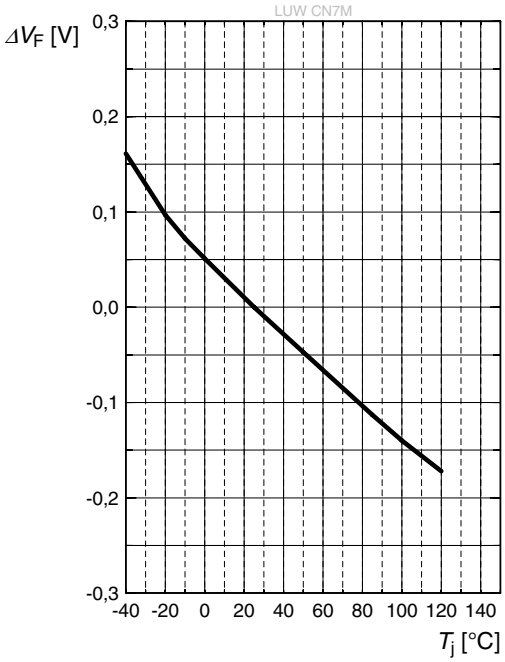
Cx, Cy = $f(I_F)$; T_S = 25 °C



Discontinued

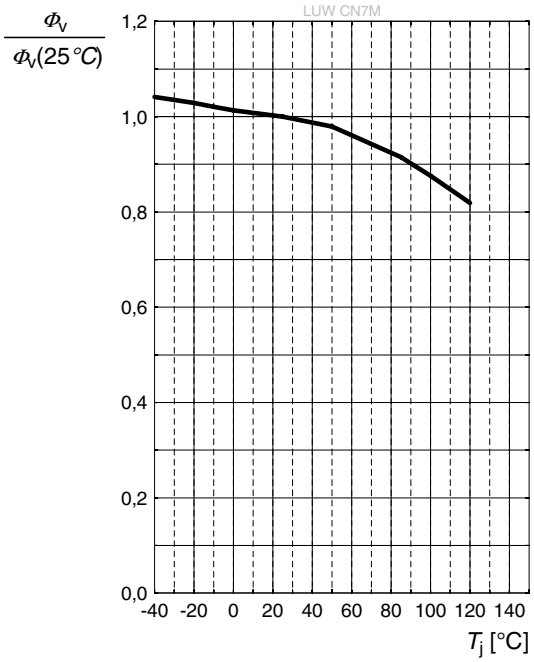
Forward Voltage [6]

$\Delta V_F = V_F - V_F(25\ °C) = f(T_j);\ I_F = 200\ mA$



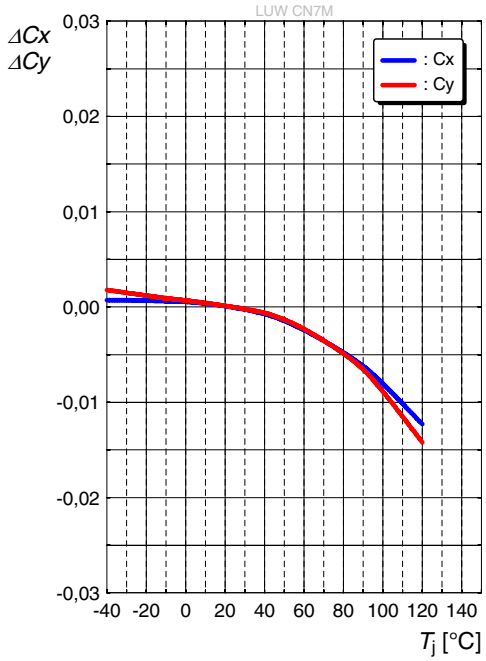
Relative Luminous Flux [6]

$\Phi_v/\Phi_v(25\ °C) = f(T_j);\ I_F = 200\ mA$



Chromaticity Coordinate Shift [6]

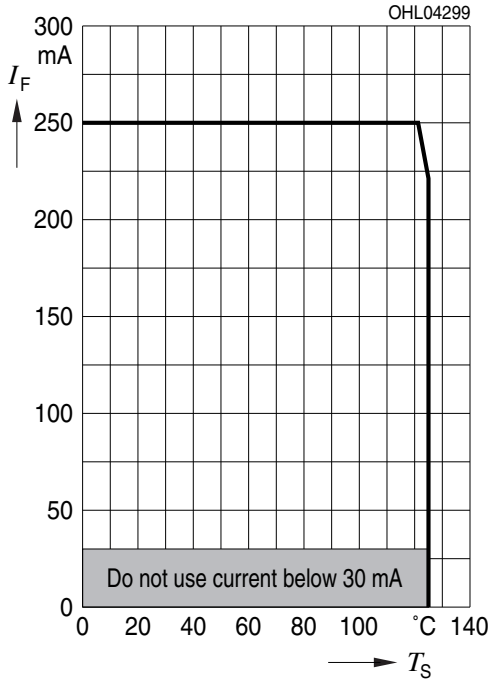
Cx, Cy = $f(T_j)$; I_F = 200 mA



Discontinued

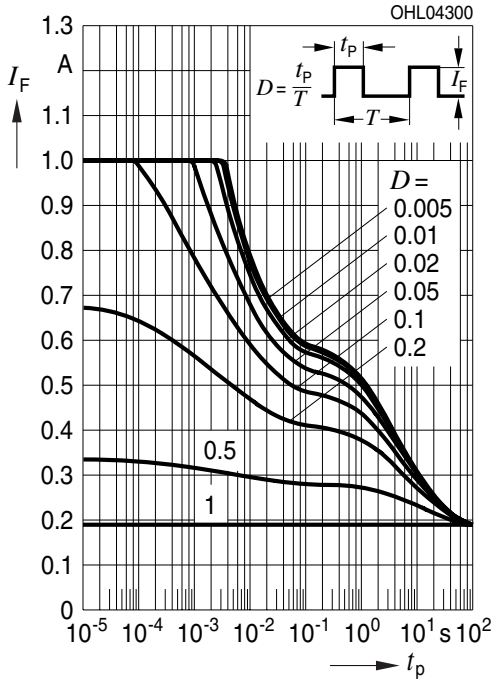
Max. Permissible Forward Current

$I_F = f(T)$



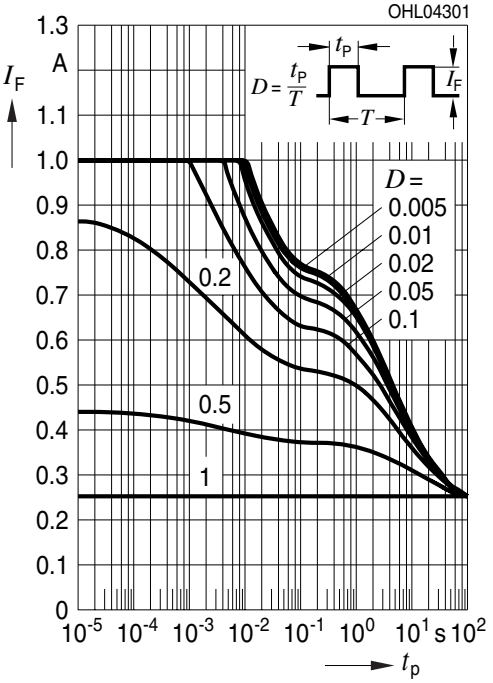
Permissible Pulse Handling Capability

$I_F = f(t_p)$; D: Duty cycle; T_S = 25 °C



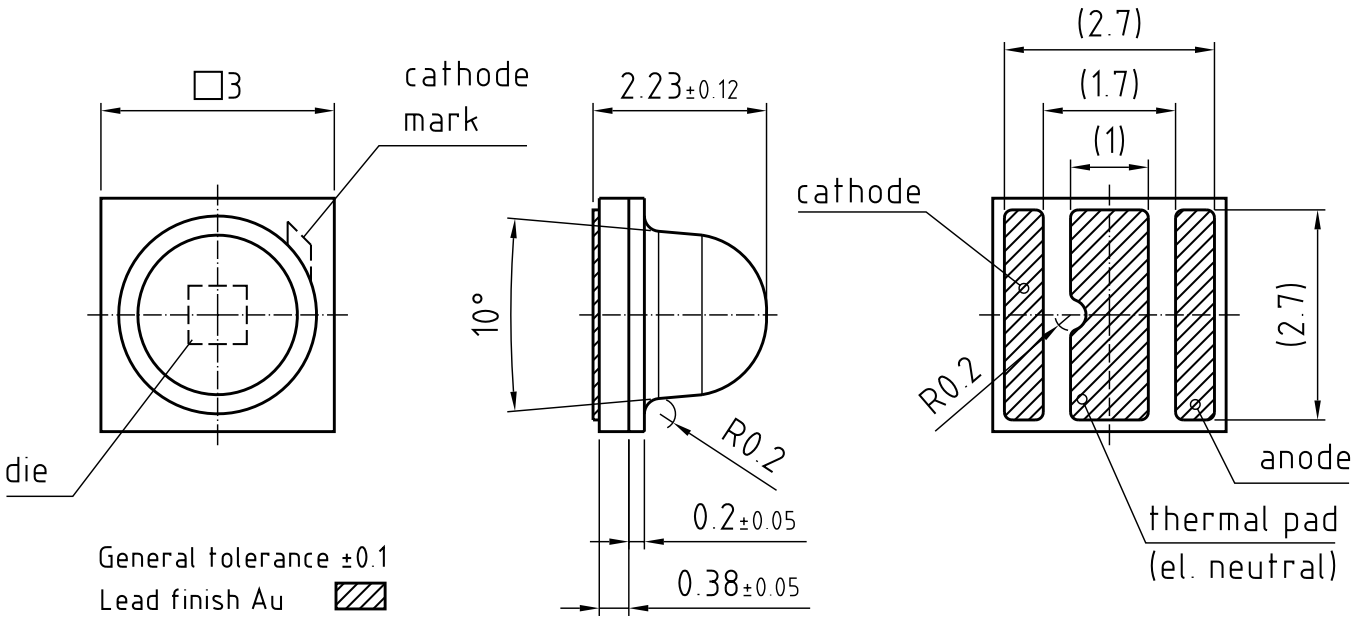
Permissible Pulse Handling Capability

$I_F = f(t_p)$; D: Duty cycle; T_S = 85 °C



Discontinued

Dimensional Drawing [8)]



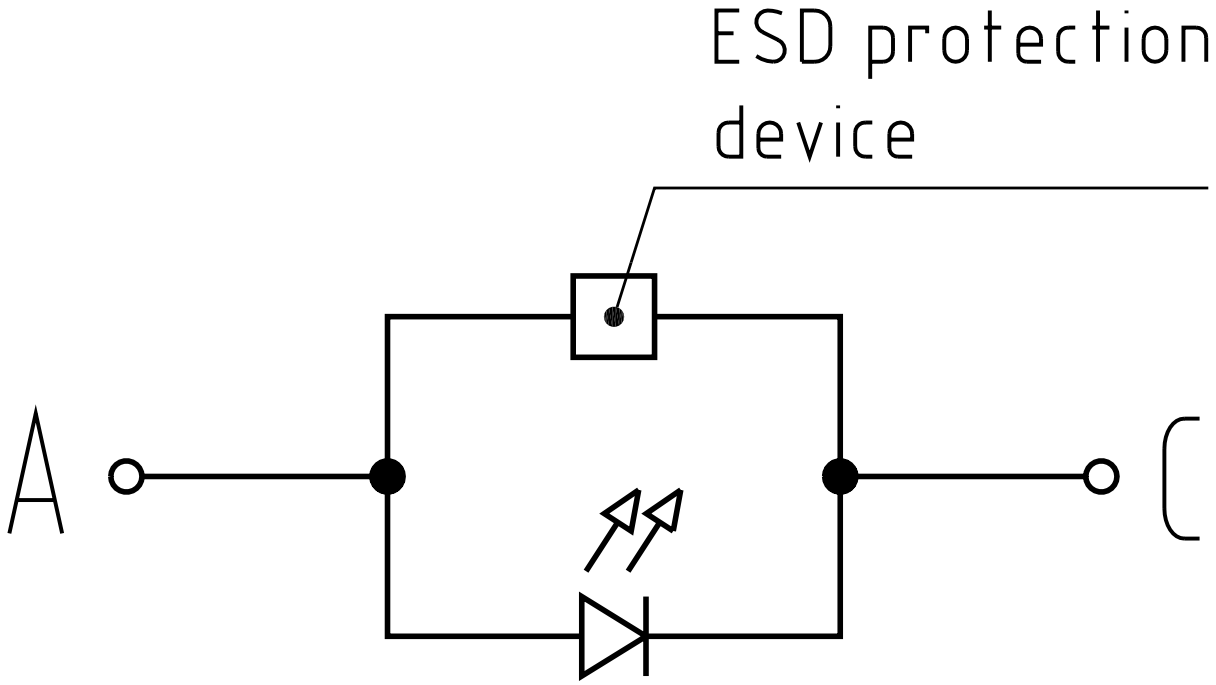
C63062-A4072-A1..-06

Further Information:

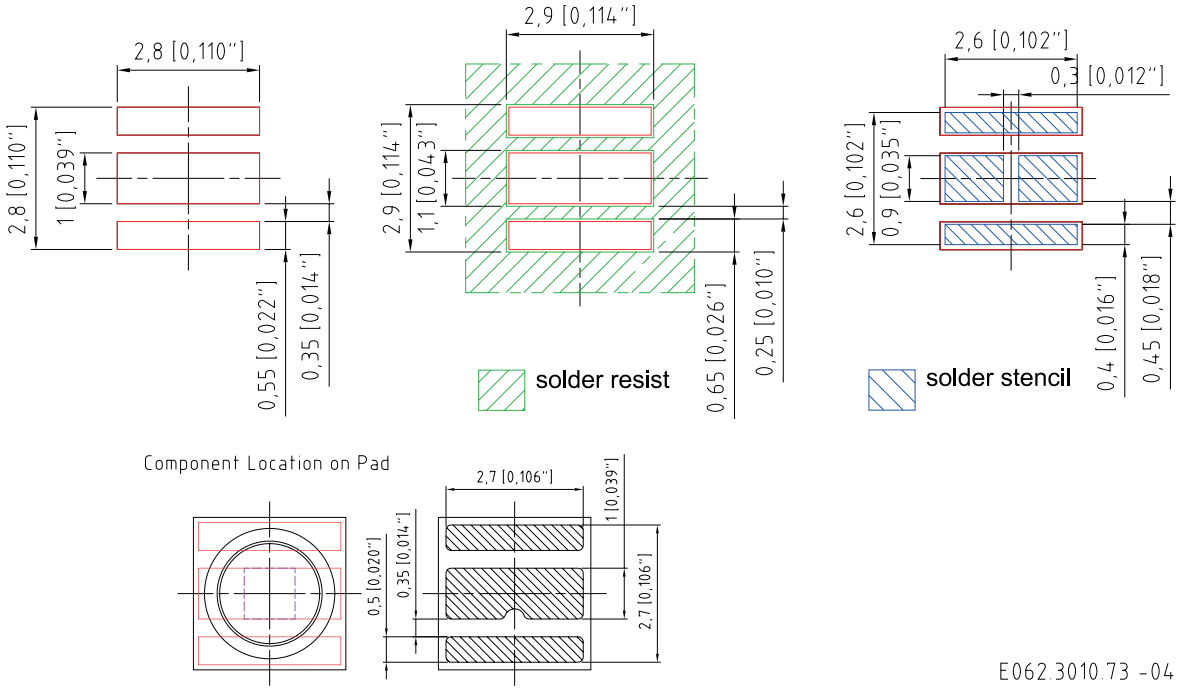
Approximate Weight:	26.0 mg
Package marking:	Cathode
Corrosion test:	Class: 3B Test condition: 40°C / 90 % RH / 15 ppm H_2S / 14 days (stricter than IEC 60068-2-43)
ESD advice:	The device is protected by ESD device which is connected in parallel to the Chip.

Discontinued

Electrical Internal Circuit



Recommended Solder Pad [8)]

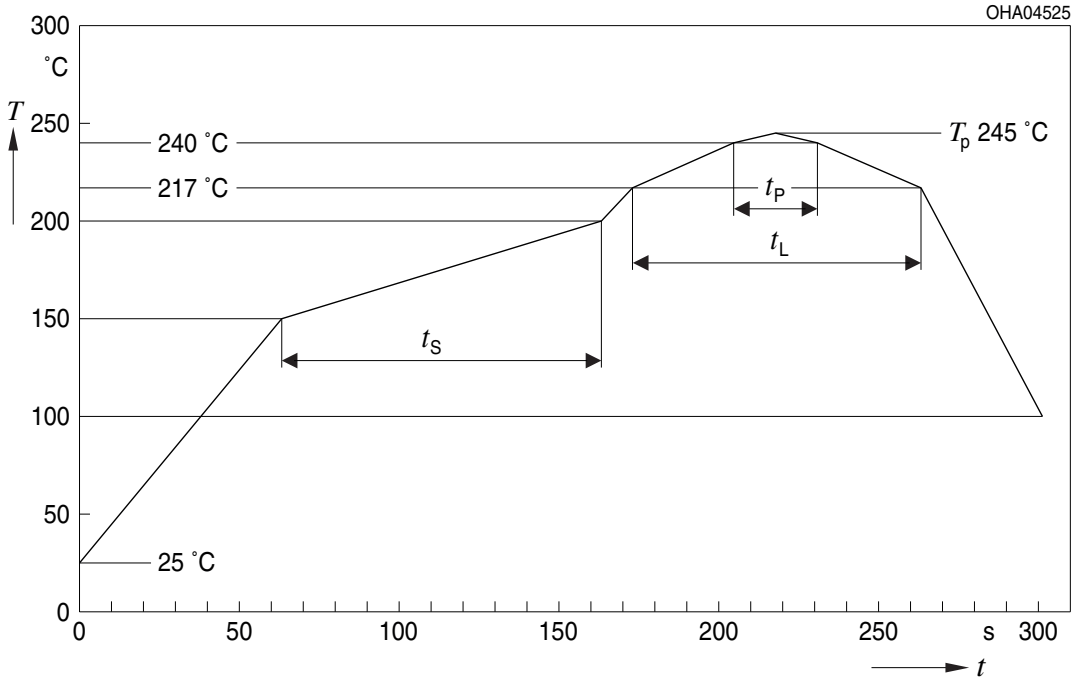


For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning.

Discontinued

Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E

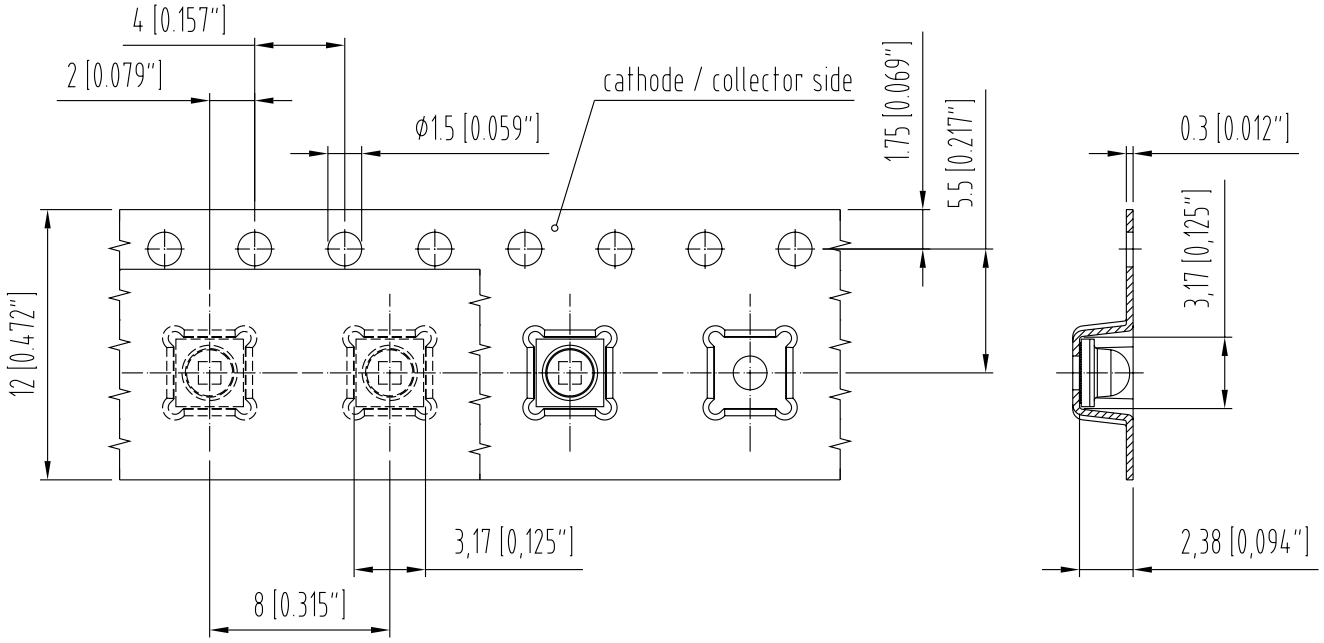


Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*) 25 °C to 150 °C			2	3	K/s
Time t_S T_{Smin} to T_{Smax}	t_S	60	100	120	s
Ramp-up rate to peak*) T_{Smax} to T_P			2	3	K/s
Liquidus temperature	T_L		217		°C
Time above liquidus temperature	t_L		80	100	s
Peak temperature	T_P		245	260	°C
Time within 5 °C of the specified peak temperature T_P - 5 K	t_P	10	20	30	s
Ramp-down rate* T_P to 100 °C			3	6	K/s
Time 25 °C to T_P				480	s

All temperatures refer to the center of the package, measured on the top of the component
* slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

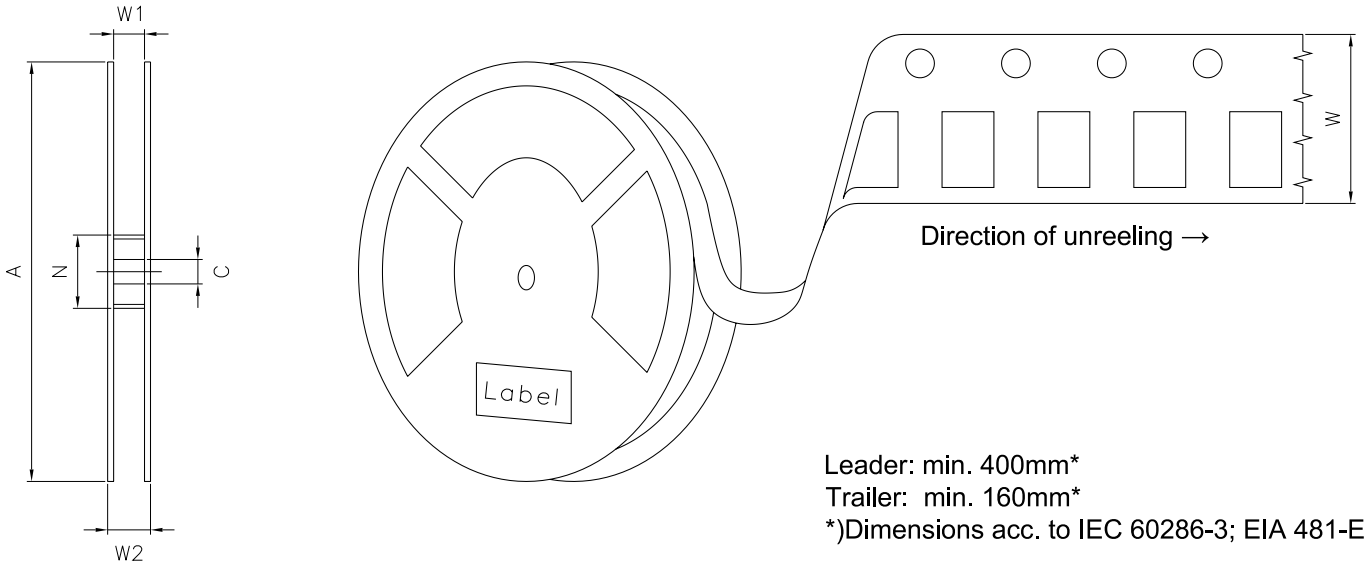
Discontinued

Taping [8)]



C63062-A4054-B6-06

Tape and Reel [9)]



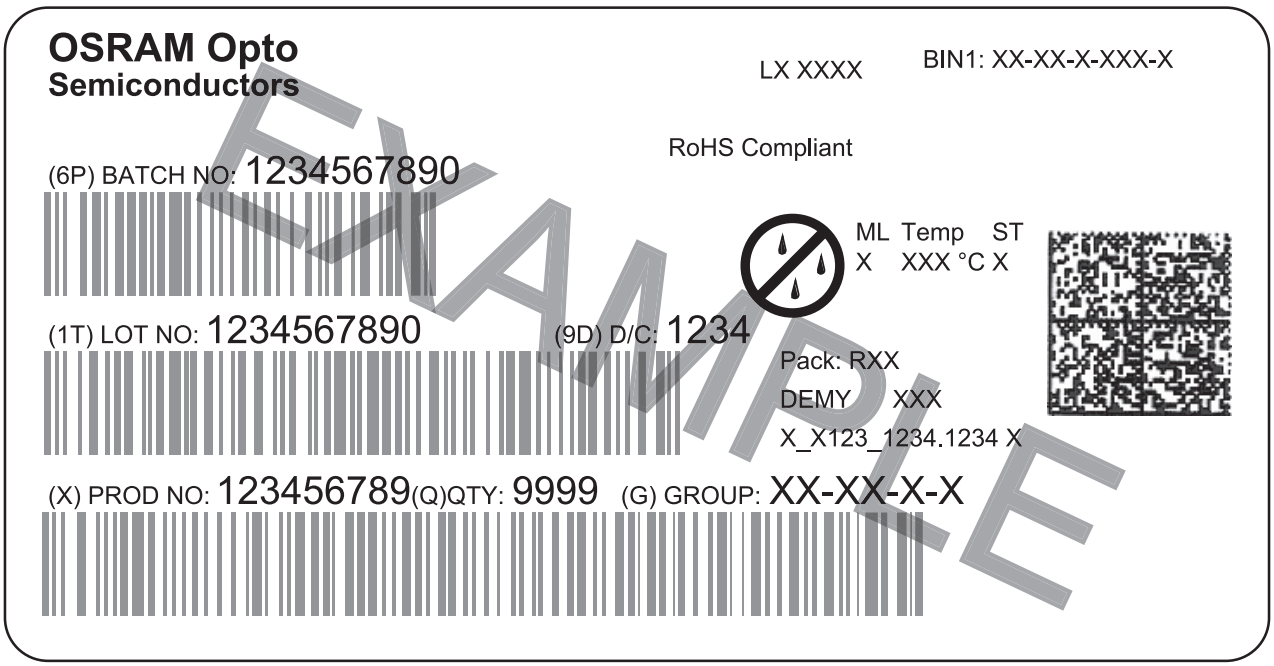
Leader: min. 400mm*
Trailer: min. 160mm*
*)Dimensions acc. to IEC 60286-3; EIA 481-E

Reel Dimensions

A	W	N_{min}	W_1	$W_{2\,max}$	Pieces per PU
180 mm	12 + 0.3 / - 0.1 mm	60 mm	12.4 + 2 mm	18.4 mm	600
330 mm	12 + 0.3 / - 0.1 mm	60 mm	12.4 + 2 mm	18.4 mm	3000

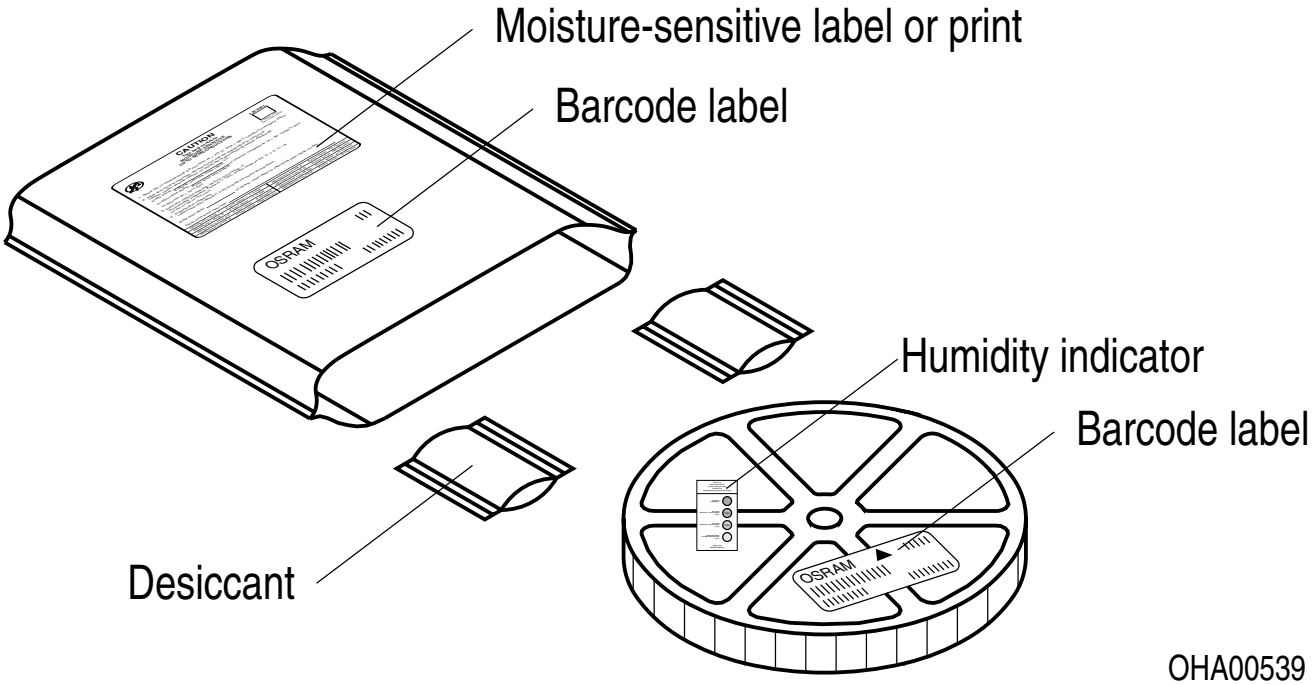
Discontinued

Barcode-Product-Label (BPL)



OHA04563

Dry Packing Process and Materials [8)]

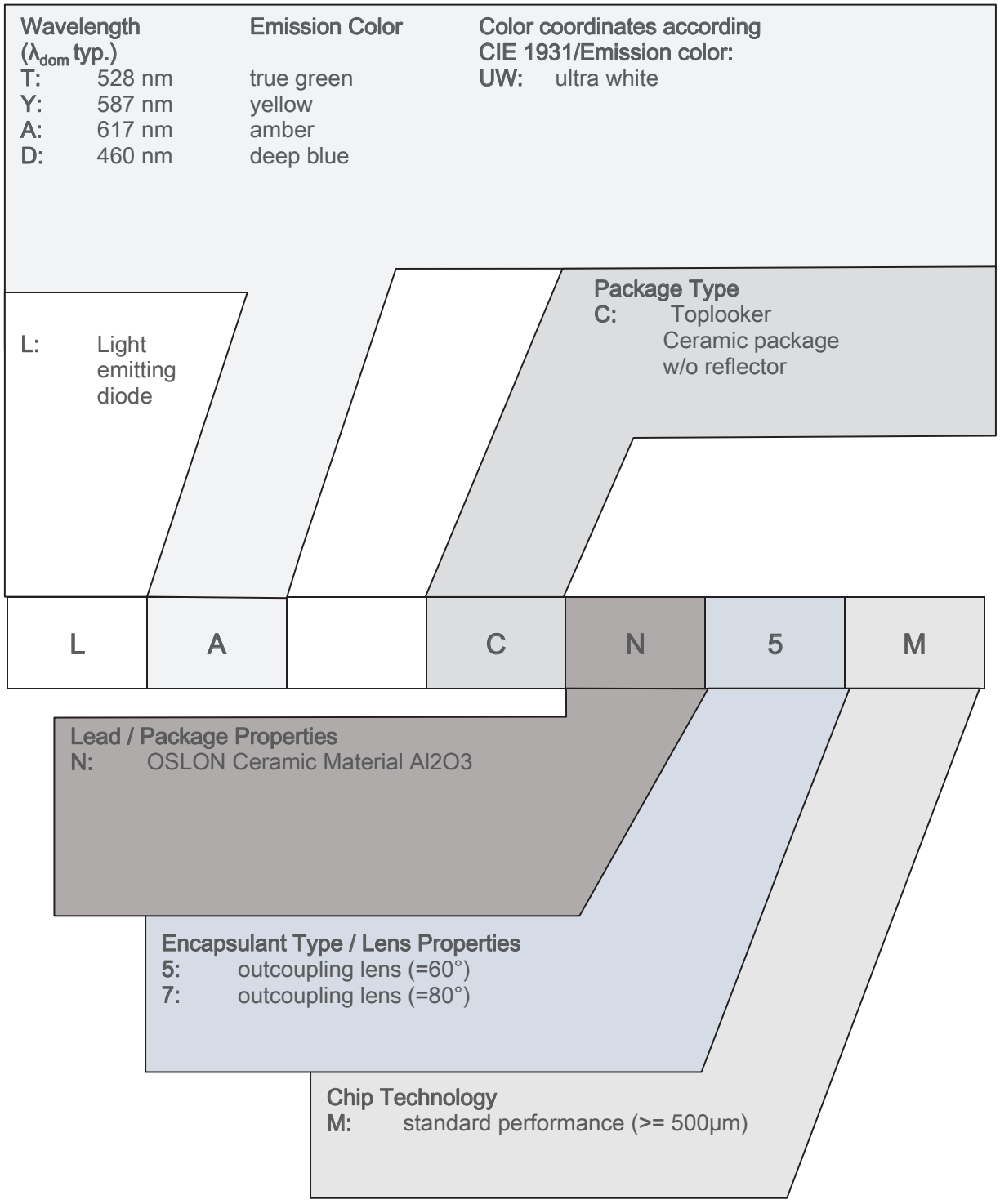


OHA00539

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

Discontinued

Type Designation System



Discontinued

Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into the class **moderate risk (exposure time 0.25 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit www.osram-os.com/appnotes

Disclaimer

Attention please!
The information describes the type of component and shall not be considered as assured characteristics.
Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.
For information on the types in question please contact our Sales Organization.
If printed or downloaded, please find the latest version on the OSRAM OS website.

Packing
Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications
OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.
OSRAM OS products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and buyer and /or customer will analyze and coordinate the customer-specific request between OSRAM OS and buyer and/or customer.

Glossary

1) **Brightness:** Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of ±8 % and an expanded uncertainty of ±11 % (acc. to GUM with a coverage factor of k = 3).

2) **Reverse Operation:** This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.

3) **Chromaticity coordinate groups:** Chromaticity coordinates are measured during a current pulse of typically 25 ms, with an internal reproducibility of ±0.005 and an expanded uncertainty of ±0.01 (acc. to GUM with a coverage factor of k = 3).

4) **Forward Voltage:** The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of ±0.05 V and an expanded uncertainty of ±0.1 V (acc. to GUM with a coverage factor of k = 3).

5) **Thermal Resistance:** Rth max is based on statistic values (6σ).

6) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.

7) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.

8) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.

9) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

Revision History

Version	Date	Change
1.8	2020-03-23	Schematic Transportation Box Dimensions of Transportation Box
1.9	2020-08-17	Discontinued

Published by OSRAM Opto Semiconductors GmbH
Leibnizstraße 4, D-93055 Regensburg

EU RoHS and China RoHS compliant product

此产品符合欧盟 RoHS 指令的要求；
按照中国的相关法规和标准，不含有毒有害物质或元素。

Discontinued

OSRAM
Opto Semiconductors